



Dept.: E/M

By: EHK/CES/mai

OSMM&N File No. 248983US2DIV

Serial No. 10/780,644

In the matter of the Application of: Michiaki HIYOSHI

For: HERMETICALLY SEALED SEMICONDUCTOR POWER MODULE AND
LARGE SCALE MODULE COMPRISING THE SAME

Due Date: N/A

The following has been received in the U.S. Patent Office on the date stamped hereon:

- Dep. Acct. Order Form
- Amendment Cover Letter
- Amendment under 37 CFR §1.312



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Docket No. 248983US2DIV

IN RE APPLICATION OF: Michiaki HIYOSHI

SERIAL NO: 10/780,644

FILED: February 19, 2004

FOR: HERMETICALLY SEALED SEMICONDUCTOR POWER MODULE AND LARGE SCALE MODULE
COMPRISING THE SAME

APR 12 2005

COMMISSIONER FOR PATENTS
ALEXANDRIA, VIRGINIA 22313

SIR:

Transmitted herewith is an amendment under 37 CFR §1.312 in the above-identified application.

- ☒ No additional fee is required
- ☐ Small entity status of this application under 37 C.F.R. §1.9 and §1.27 is claimed.
- ☐ Additional documents filed herewith:

The Fee has been calculated as shown below:

| CLAIMS | CLAIMS REMAINING | | HIGHEST NUMBER PREVIOUSLY PAID | NO. EXTRA CLAIMS | RATE | CALCULATIONS |
|-------------|---------------------|--|---|------------------------|-----------|--------------|
| TOTAL | 5 | MINUS | 20 | 0 | x \$50 = | \$0.00 |
| INDEPENDENT | 1 | MINUS | 3 | 0 | x \$200 = | \$0.00 |
| | | <input type="checkbox"/> MULTIPLE DEPENDENT CLAIMS | | | + \$360 = | \$0.00 |
| | | TOTAL OF ABOVE CALCULATIONS | | | | \$0.00 |
| | | <input type="checkbox"/> Reduction by 50% for filing by Small Entity | | | | \$0.00 |
| | | <input type="checkbox"/> Recordation of Assignment | | | + \$40 = | \$0.00 |
| | | TOTAL | | | | \$0.00 |

- ☐ A check in the amount of \$0.00 is attached.
- ☐ Credit card payment form is attached to cover the fees in the amount of \$0.00
- ☒ Please charge any additional Fees for the papers being filed herewith and for which no check or credit card payment is enclosed herewith, or credit any overpayment to deposit Account No. 15-0030. A duplicate copy of this sheet is enclosed.
- ☒ If these papers are not considered timely filed by the Patent and Trademark Office, then a petition is hereby made under 37 C.F.R. §1.136, and any additional fees required under 37 C.F.R. §1.136 for any necessary extension of time may be charged to Deposit Account No. 15-0030. A duplicate copy of this sheet is enclosed.

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DOCKET NO: 248983US2DIV



IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF :
MICHIAKI HIYOSHI : EXAMINER: DOUGLAS W. OWENS
SERIAL NO: 10/780,644 :
FILED: FEBRUARY 19, 2004 : GROUP ART UNIT: 2811
FOR: HERMETICALLY SEALED :
SEMICONDUCTOR POWER MODULE
AND LARGE SCALE MODULE
COMPRISING THE SAME

AMENDMENT UNDER 37 CFR §1.312

COMMISSIONER FOR PATENTS
ALEXANDRIA, VIRGINIA 22313

SIR:

In response to the Notice of Allowance dated January 18, 2005, please amend the
above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on
page 2 of this paper.

Remarks begin on page 4 of this paper.

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